# **Darlington Power Transistors**

### **DPAK For Surface Mount Applications**

Designed for general purpose power and switching such as output or driver stages in applications such as switching regulators, convertors, and power amplifiers.

#### **Features**

- Lead Formed for Surface Mount Applications in Plastic Sleeves (No Suffix)
- Straight Lead Version in Plastic Sleeves ("-1" Suffix)
- Monolithic Construction With Built-in Base-Emitter Shunt Resistors
- High DC Current Gain  $h_{FE} = 2500$  (Typ) @  $I_C = 4.0$  Adc
- Epoxy Meets UL 94 V-0 @ 0.125 in
- ESD Ratings:
  - Human Body Model, 3B > 8000 V
  - Machine Model, C > 400 V
- NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- Pb-Free Package is Available\*

#### **MAXIMUM RATINGS**

| Rating   | Symbol                            | Max           | Unit      |
|--|-----------------------------------|---------------|-----------|
| Collector-Emitter Voltage  | V <sub>CEO</sub>                  | 80            | Vdc       |
| Collector-Base Voltage   | V <sub>CB</sub>                   | 80            | Vdc       |
| Emitter-Base Voltage   | V <sub>EB</sub>                   | 5             | Vdc       |
| Collector Current<br>Continuous<br>Peak                                    | I <sub>C</sub>                    | 4<br>8        | Adc       |
| Base Current   | Ι <sub>Β</sub>                    | 100           | mAdc      |
| Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C          | P <sub>D</sub>                    | 20<br>0.16    | W<br>W/°C |
| Total Power Dissipation (Note 1) @ T <sub>A</sub> = 25°C Derate above 25°C | P <sub>D</sub>                    | 1.75<br>0.014 | W<br>W/°C |
| Operating and Storage Junction<br>Temperature Range                        | T <sub>J</sub> , T <sub>stg</sub> | -65 to +150   | °C        |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



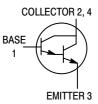
#### ON Semiconductor®

http://onsemi.com

# SILICON POWER TRANSISTORS 4 AMPERES, 80 VOLTS, 20 WATTS



DPAK CASE 369C STYLE 1



#### **MARKING DIAGRAM**



A = Assembly Location

Y = Year WW = Work Week J6039 = Device Code G = Pb-Free Package

#### **ORDERING INFORMATION**

| Device        | Package           | Shipping <sup>†</sup> |
|---------------|-------------------|-----------------------|
| MJD6039T4     | DPAK              | 2,500/Tape & Reel     |
| MJD6039T4G    | DPAK<br>(Pb-Free) | 2,500/Tape & Reel     |
| NJVMJD6039T4G | DPAK<br>(Pb-Free) | 2,500/Tape & Reel     |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

These ratings are applicable when surface mounted on the minimum pad sizes recommended.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### THERMAL CHARACTERISTICS

| Characteristic                                   | Symbol         | Max  | Unit |
|--|----------------|------|------|
| Thermal Resistance, Junction-to-Case             | $R_{	heta JC}$ | 6.25 | °C/W |
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{	heta JA}$ | 71.4 | °C/W |

<sup>2.</sup> These ratings are applicable when surface mounted on the minimum pad sizes recommended.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

| Characteristic  | Symbol                | Min         | Max    | Unit |
|---|-----------------------|-------------|--------|------|
| OFF CHARACTERISTICS   |                       |             |        | •    |
| Collector–Emitter Sustaining Voltage (I <sub>C</sub> = 30 mAdc, I <sub>B</sub> = 0)           | V <sub>CEO(sus)</sub> | 80          | -      | Vdc  |
| Collector-Cutoff Current (V <sub>CE</sub> = 40 Vdc, I <sub>B</sub> = 0)                       | I <sub>CEO</sub>      | -           | 10     | μAdc |
| ON CHARACTERISTICS (Note 3)   |                       |             |        |      |
| DC Current Gain   | h <sub>FE</sub>       | 1000<br>500 | -<br>- | -    |
| Collector–Emitter Saturation Voltage (I <sub>C</sub> = 2 Adc, I <sub>B</sub> = 8 mAdc)        | V <sub>CE(sat)</sub>  | -           | 2.5    | Vdc  |
| Base-Emitter On Voltage<br>(I <sub>C</sub> = 2 Adc, V <sub>CE</sub> = 4 Vdc)                  | V <sub>BE(on)</sub>   | -           | 2.8    | Vdc  |
| DYNAMIC CHARACTERISTICS   | ·                     |             |        |      |
| Small-Signal Current Gain<br>(I <sub>C</sub> = 0.75 Adc, V <sub>CE</sub> = 10 Vdc, f = 1 kHz) | h <sub>fe</sub>       | 25          | -      | _    |
| Output Capacitance<br>(V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 0.1 MHz)             | C <sub>ob</sub>       | -           | 100    | pF   |

<sup>3.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%.

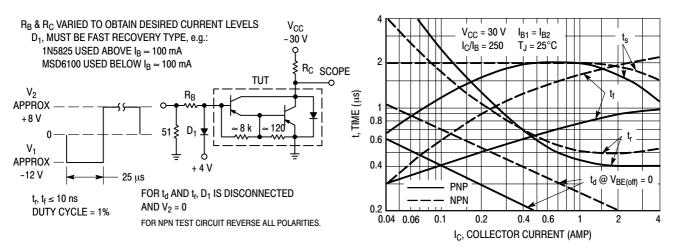


Figure 1. Switching Times Test Circuit

Figure 2. Switching Times

#### TYPICAL ELECTRICAL CHARACTERISTICS

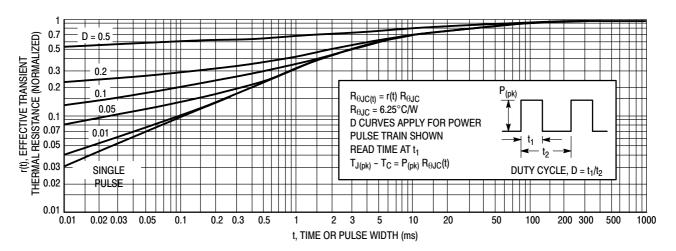


Figure 3. Thermal Response

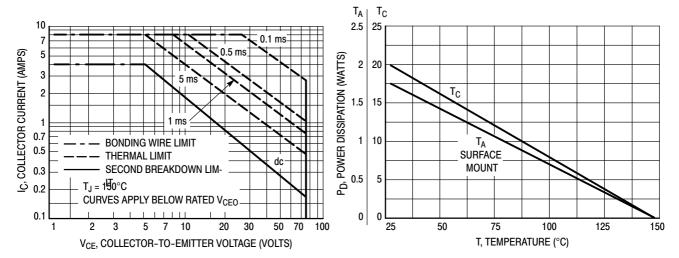


Figure 4. Maximum Rated Forward Biased Safe Operating Area

Figure 5. Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C$  –  $V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figures 6 and 7 is based on  $T_{J(pk)} = 150^{\circ} C$ ;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} < 150^{\circ} C$ .  $T_{J(pk)}$  may be calculated from the data in Figure 5. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

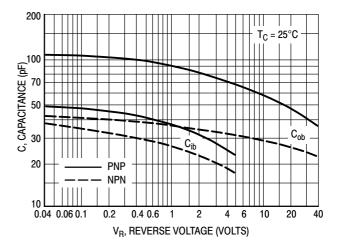


Figure 6. Capacitance

#### TYPICAL ELECTRICAL CHARACTERISTICS

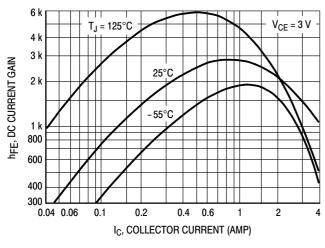


Figure 7. DC Current Gain

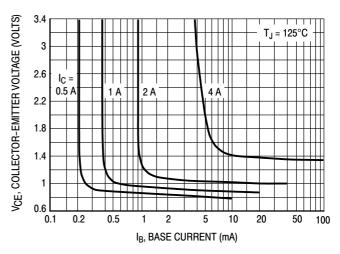


Figure 8. Collector Saturation Region

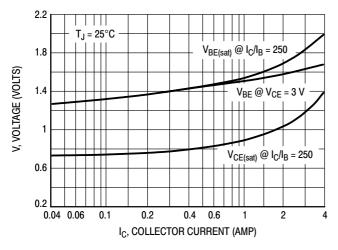


Figure 9. "On" Voltages

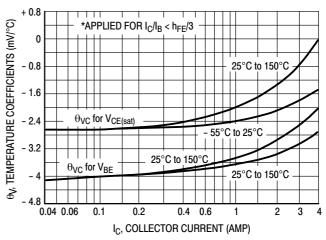


Figure 10. Temperature Coefficients

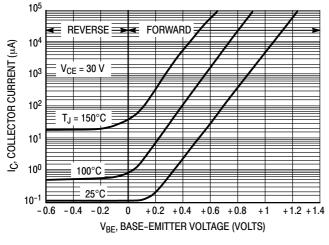


Figure 11. Collector Cut-Off Region

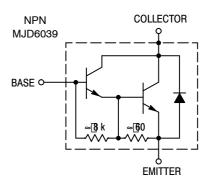
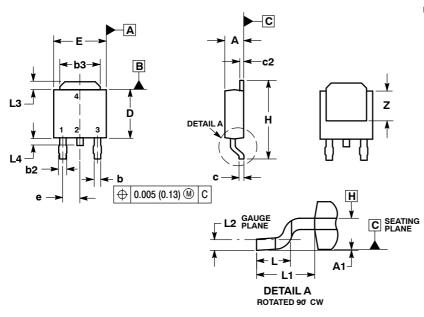


Figure 12. Darlington Schematic

#### PACKAGE DIMENSIONS

#### **DPAK** CASE 369C-01 ISSUE D

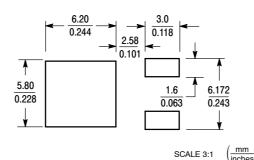


#### NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994. . CONTROLLING DIMENSION: INCHES.
- THERMAL PAD CONTOUR OPTIONAL WITHIN DI-MENSIONS b3, L3 and Z.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0 006 INCHES PER SIDE
- 5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.

|     | INCHES MILLIM |       |          | IETERS |
|-----|---------------|-------|----------|--------|
| DIM | MIN           | MAX   | MIN      | MAX    |
| Α   | 0.086         | 0.094 | 2.18     | 2.38   |
| A1  | 0.000         | 0.005 | 0.00     | 0.13   |
| b   | 0.025         | 0.035 | 0.63     | 0.89   |
| b2  | 0.030         | 0.045 | 0.76     | 1.14   |
| b3  | 0.180         | 0.215 | 4.57     | 5.46   |
| С   | 0.018         | 0.024 | 0.46     | 0.61   |
| c2  | 0.018         | 0.024 | 0.46     | 0.61   |
| D   | 0.235         | 0.245 | 5.97     | 6.22   |
| Е   | 0.250         | 0.265 | 6.35     | 6.73   |
| е   | 0.090 BSC     |       | 2.29 BSC |        |
| Н   | 0.370         | 0.410 | 9.40     | 10.41  |
| L   | 0.055         | 0.070 | 1.40     | 1.78   |
| L1  | 0.108 REF     |       | 2.74     | REF    |
| L2  | 0.020 BSC     |       | 0.51 BSC |        |
| L3  | 0.035         | 0.050 | 0.89     | 1.27   |
| L4  |               | 0.040 |          | 1.01   |
| Z   | 0.155         |       | 3.93     |        |

#### **SOLDERING FOOTPRINT\***



STYLE 1: PIN 1. BASE 2. COLL

- COLLECTOR
- **EMITTER** 3. COLLECTOR

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: MJD6039T4G